

0,80mm HI-SPEED SOCKET QSE SERIES

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?QSE

Insulator Material: Liquid Crystal Polymer

Terminal Material: Phosphor Bronze

Plating:
Au over 50µ" (1,27µm) Ni
Current Rating:
Contacts: 2A @ 80°C
Ground Plane: 9.5A @ 80°C
Operating Temp Range:
-55°C to ±125°C

Ground Plane: 9.5A @ 80 Operating Temp Range: -55°C to +125°C Voltage Rating: 225 VAC mated with QTE & 5mm Stack Height RoHS Compliant: Ves

Processing:

Max Processing Temp: 230°C for 60 seconds, or 260°C for 20 seconds 3x Lead-Free Solderable:

SMT Lead Coplanarity: (0,10mm) .004" max (020-060) (0,15mm) .006" max (080) Board Stacking:

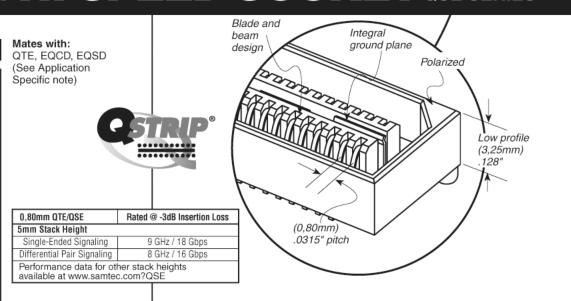
For applications requiring more than two connectors per board, contact ipg@samtec.com

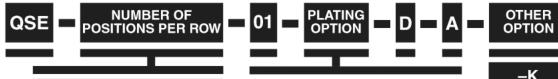


APPLICATION SPECIFIC OPTION

- 30µ" (0,76µm) Gold (Specify -H plating for Data Rate cable mating applications)
- Edge Mount
- 100 positions per row
- Guide Posts and Friction Lock options
- 11mm, 14mm, 16mm, 19mm, 22mm, 25mm and 30mm stack height Call Samtec.

Note: Some lengths, styles and options are non-standard, non-returnable.





-020, -040, -060, -080 (40 total positions per bank)

= 10µ" (0,25µm) Gold on Signal Pins and Ground Plane, Gold Flash on tails

— **├** Gold Flash on Signal Pins and Ground Plane = (8,25mm) .325"

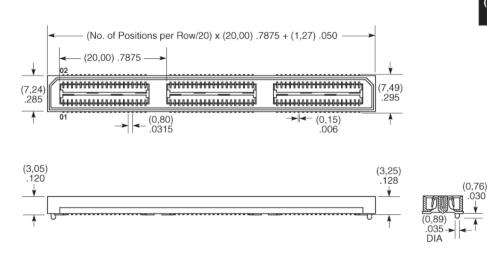
DIA Polyimide

Film Pick &

Place Pad

-TR

= Tape & Reel Packaging (-060 positions maximum)



Due to technical progress, all designs, specifications and components are subject to change without notice.

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